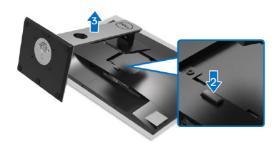
1. Disassembly Procedures

- S1 Turn off the monitor.
- S2 Place the monitor on a soft cloth or cushion.

Press and hold the stand release button.

Lift the stand up and away from the monitor.



S3 Unlock 4 screws on Rear Cover

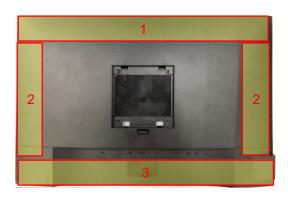


(Screw Torque: 8.5±1.0kgf)

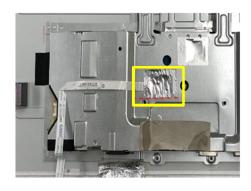
S4 Disassemble Rear Cover from the monitor

Notice the disassembly order:

- 1) Disassemble the Top part
- 2) Disassemble the Left / Right part
- 3) Disassemble the Bottom part
- 4) Remove RC from Mid-Frame

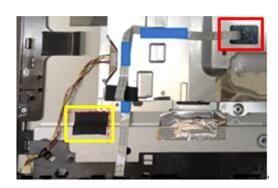


Tear off the small aluminum foil from Main SHD



Tear off the acetate adhesive tape from Panel

Pull out CTRL BD FFC cable from I/F BD and tear off it from Main SHD



Pull out USB BD cable from I/F BD and USB BD

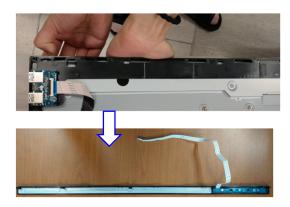


S8 Unlock 5 BZL TRIM screws



(Screw Torque: 2.0±0.5kgf)

S9 Disassemble BZL TRIM from Mid-Frame



S10 Tear off CTRL BD Mylar from CTRL BD



S11 Unlock 3 CTRL BD screws



(Screw Torque: 1.2±0.5kgf)

S12 Disassemble CTRL BD, OSD Button and PWR Button



S13 Tear off 2 large acetate adhesive tapes from the Panel



S14 Unlock 9 MF screws



(Screw Torque: 4.0±0.5kgf)

S15 Pull out LED Backlight wire from SPS BD and Panel



S16 Tear off aluminum foil and tape from LVDS cable

Pull out the LVDS cable from Panel.



\$17 Disassemble Mid-Frame from Panel

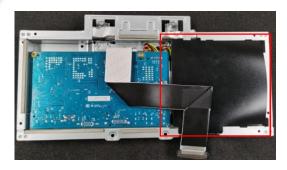


S18 Unlock USB BD screw and disassemble USB BD from Mid-Frame

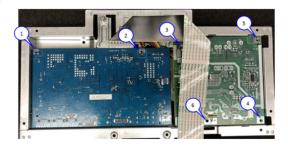


(Screw Torque: 4.5±0.5kgf)

S19 Remove Safety Mylar from SPS BD



\$20 Unlock 6 PCBA screws from PCBA



(Screw Torque: 6.5±1.0kgf)

S21 Unlock 4 hexagonal screws from Main SHD



(Screw Torque: 5.0±0.6kgf)

S22 Disassemble I/F BD from Main SHD and unplug SPS BD wire



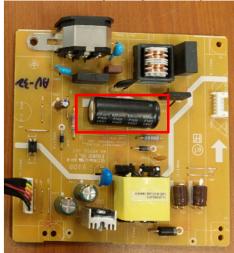
\$23 Unplug FFC LVDS cable from I/F BD



S24 Disassemble SPS BD from Main SHD



Remove electrolyte capacitors (red mark) from printed circuit boards



S13

S13-1 Cut the glue between bulk cap. and PCB with a knife



S13-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB



S13-3 Take out bulk cap. pin solder with soldering iron and absorber



S13-4 Lift the bulk cap. up and away from the PCB



2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface greater	Product has printed circuit boards
than 10 square cm)	(with a surface greater than 10 square
	cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC and	No used
HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100
	cm2
External electric cable	Product has external cables
Component contain refractory ceramic fibers	No used
Component contain radio-active substances	No used
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height >25mm, diameter > 25mm)

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Scraper Bar
- Penknife
- Soldering iron and absorber